

# Bill of Materials

TI DESIGNS  
TIDA-00060

Item	-1	Part Description	MFR	Part Number	Package	Ref Des	Notes
1	1	Board, Printed Wiring (PWB)	K&S	EIS No. 6439054			Blank PWB
2	1	Capacitor, 0.1uF, +/- 10%, 16V	Panasonic	ECJ-3VBIC104K	1206	C2 / (C1)	
3	2	Capacitor, 1.0uF, +/- 10%, 16V	Panasonic	ECJ-3VFIC105K	1206	C5,C9 / (C6,C10)	
4	2	Capacitor, 10uF, +/- 20%, 10V, Tant.	Panasonic	ECS-T1AY106R	"A"	C4,C8 / (C3,C7)	
5	4	Jumper Post, Male, 2-Position	Amp	4-103239-0x2	100m ctrs	TP3, TP4, P3, W17 / (TP1,2,P1,2,W13,15)	
6	1	Jumper Post, Female, 2-Position	Samtec	SS-102-G-1C	100m ctrs	W18 / (W14,16)	
7	3	Jumper Post, Male, 3-Position	Amp	4-103239-0x3	100m ctrs	W3, W4, W11 / (W1,2,5,6)	Make From Item 5, Amp 4-103239-0
8	2	Resistor, 0.0 Ohm, +/- 1%, 1/8W	Dale	CRCW1206000F	1206	R17, R18 / (R7-10)	
9	1	Resistor, 100 Ohm, +/- 1%, 1/8W	Dale	CRCW1206101F	1206	R5 / (R4,6)	
10	1	Resistor, 453 Ohm, +/- 1%, 1/8W	Dale	CRCW1206453F	1206	R21 / (R2)	
11	3	Resistor, 51.1 Ohm, +/- 1%, 1/8W	Dale	CRCW120651R1F	1206	R12, R14-R16 / (R1,3,11,13,19,20)	R1 & R12, Not installed
12	1	Banana Jack, Black	Aletron	ST-351B		J18 / (J14)	
13	1	Banana Jack, Red	Aletron	ST-351A		J17 / (J13)	
14	2	SMA RF/ Coax. Conn., SMA Jack	Amphenol	901-144-8RFX		J7, J8 / (J1,2)	



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